8-bit dual supply translating transceiver with configurable voltage translation; 3-state

Rev. 02 — 28 April 2009

Product data sheet

1. General description

The 74AVCH8T245 is an 8-bit, dual supply transceiver that enables bidirectional level translation. It features two data input-output ports (An and Bn), a direction control input (DIR), a output enable input (\overline{OE}) and dual supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied at any voltage between 0.8 V and 3.6 V making the device suitable for translating between any of the low voltage nodes (0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V). Pins An, \overline{OE} and DIR are referenced to $V_{CC(A)}$ and pins Bn are referenced to $V_{CC(B)}$. A HIGH on DIR allows transmission from An to Bn and a LOW on DIR allows transmission from B to A. The output enable input (\overline{OE}) can be used to disable the outputs so the buses are effectively isolated.

The device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either $V_{CC(A)}$ or $V_{CC(B)}$ are at GND level, both A and B outputs are in the high-impedance OFF-state. The bus-hold circuitry on the powered-up side always stays active.

The 74AVCH8T245 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

2. Features

- Wide supply voltage range:
 - ◆ V_{CC(A)}: 0.8 V to 3.6 V
 - ◆ V_{CC(B)}: 0.8 V to 3.6 V
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114E Class 3B exceeds 8000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Maximum data rates:
 - ◆ 380 Mbit/s (≥ 1.8 V to 3.3 V translation)
 - ◆ 260 Mbit/s (≥ 1.1 V to 3.3 V translation)



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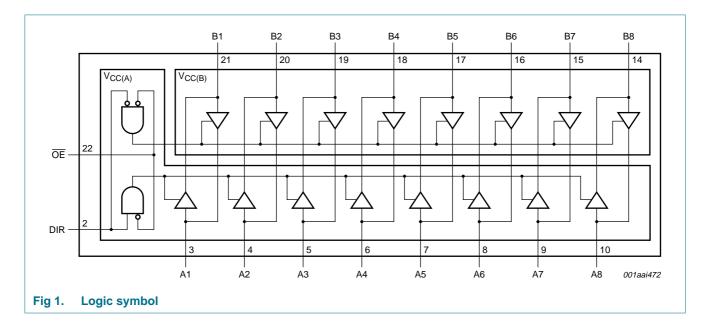
- ◆ 260 Mbit/s (≥ 1.1 V to 2.5 V translation)
- ◆ 210 Mbit/s (≥ 1.1 V to 1.8 V translation)
- 150 Mbit/s (\geq 1.1 V to 1.5 V translation)
- 100 Mbit/s (\geq 1.1 V to 1.2 V translation)
- Suspend mode
- Bus hold on data inputs
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

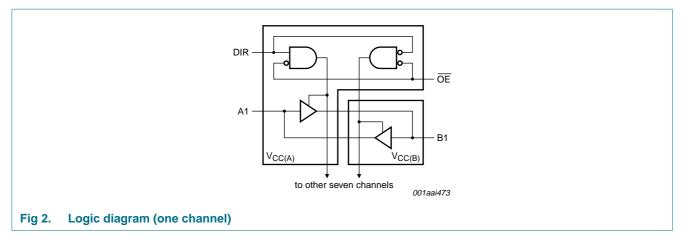
| Type number | Package | | | |
|---------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74AVCH8T245PW | –40 °C to +125 °C | TSSOP24 | plastic thin shrink small outline package; 24 leads; body width 4.4 mm | SOT355-1 |
| 74AVCH8T245BQ | –40 °C to +125 °C | DHVQFN24 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm | SOT815-1 |

4. Functional diagram

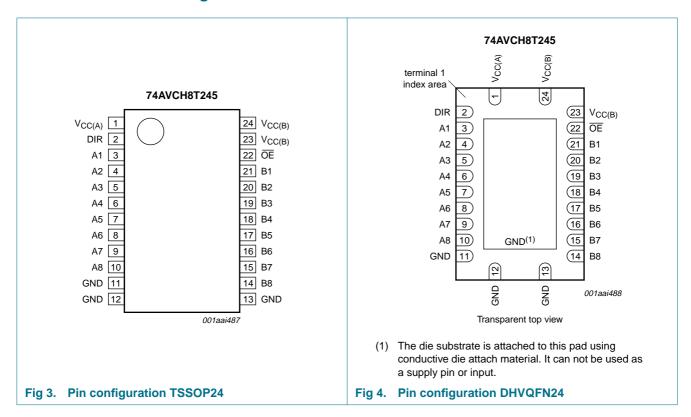


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5. Pinning information



5.1 Pinning

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| Table 2. | Pin description | |
|--------------------|--------------------------------|---|
| Symbol | Pin | Description |
| V _{CC(A)} | 1 | supply voltage A (An, $\overline{\text{OE}}$ and DIR inputs are referenced to $V_{\text{CC(A)}})$ |
| DIR | 2 | direction control |
| A1 to A8 | 3, 4, 5, 6, 7, 8, 9, 10 | data input or output |
| GND ^[1] | 11 | ground (0 V) |
| GND ^[1] | 12 | ground (0 V) |
| GND ^[1] | 13 | ground (0 V) |
| B1 to B8 | 21, 20, 19, 18, 17, 16, 15, 14 | data input or output |

output enable input (active LOW)

supply voltage B (Bn inputs are referenced to V_{CC(B)})

supply voltage B (Bn inputs are referenced to V_{CC(B)})

5.2 Pin description

[1] All GND pins must be connected to ground (0 V).

6. Functional description

Table 3.Function table^[1]

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V_{CC(B)}

V_{CC(B)}

| Supply voltage | Input | | Input/output ^[3] | Input/output ^[3] | | |
|---|-------------------|--------------------|-----------------------------|-----------------------------|--|--|
| V _{CC(A)} , V _{CC(B)} | OE ^[2] | DIR ^[2] | An ^[2] | Bn | | |
| 0.8 V to 3.6 V | L | L | An = Bn | input | | |
| 0.8 V to 3.6 V | L | Н | input | Bn = An | | |
| 0.8 V to 3.6 V | Н | Х | Z | Z | | |
| GND ^[3] | Х | Х | Z | Z | | |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

[2] The An, DIR and OE input circuit is referenced to V_{CC(A)}; The Bn input circuit is referenced to V_{CC(B)}.

[3] If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|--------------------|-------------------------|----------------------------|-----------------------|-----------------|------|
| V _{CC(A)} | supply voltage A | | -0.5 | +4.6 | V |
| V _{CC(B)} | supply voltage B | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +4.6 | V |
| I _{OK} | output clamping current | $V_{O} < 0 V$ | -50 | - | mA |
| Vo | output voltage | Active mode | <u>[1][2][3]</u> –0.5 | $V_{CCO} + 0.5$ | V |
| | | Suspend or 3-state mode | <u>[1]</u> –0.5 | +4.6 | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | - | ±50 | mA |
| I _{CC} | supply current | $I_{CC(A)}$ or $I_{CC(B)}$ | - | 100 | mA |

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Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|--------------|------|------|
| I _{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ | <u>[4]</u> _ | 500 | mW |

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 4.6 V.

For TSSOP24 package: P_{tot} derates linearly at 5.5 mW/K above 60 °C.
 For DHVQFN24 package: P_{tot} derates linearly at 4.5 mW/K above 60 °C.

8. Recommended operating conditions

| Table 5. | Recommended operating conditi | Recommended operating conditions | | | | | | |
|-----------------------|-------------------------------------|-------------------------------------|--------------|------------------|------|--|--|--|
| Symbol | Parameter | Conditions | Min | Max | Unit | | | |
| V _{CC(A)} | supply voltage A | | 0.8 | 3.6 | V | | | |
| V _{CC(B)} | supply voltage B | | 0.8 | 3.6 | V | | | |
| VI | input voltage | | 0 | 3.6 | V | | | |
| Vo | output voltage | Active mode | <u>[1]</u> 0 | V _{cco} | V | | | |
| | | Suspend or 3-state mode | 0 | 3.6 | V | | | |
| T _{amb} | ambient temperature | | -40 | +125 | °C | | | |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{CCI} = 0.8 V \text{ to } 3.6 V$ | [2] _ | 5 | ns/V | | | |
| | | | | | | | | |

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

9. Static characteristics

Table 6. Typical static characteristics at $T_{amb} = 25 \ ^{\circ}C_{1}^{[1][2]}$

| Symbol | Parameter | Conditions | Mir | п Тур | Max | Unit |
|-------------------|------------------------------------|--|--------------|--------|-------|------|
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | $I_{O} = -1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$ | - | 0.69 | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{IH} \text{ or } V_{IL}$ | | | | |
| | | I_{O} = 1.5 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 0.8 V | - | 0.07 | - | V |
| I | input leakage current | DIR, \overline{OE} input; V _I = 0 V or 3.6 V; V _{CC(A)} = V _{CC(B)} = 0.8 V to 3.6 V | - | ±0.025 | ±0.25 | μΑ |
| I _{BHL} | bus hold LOW current | A or B port; $V_I = 0.42$ V; $V_{CC(A)} = V_{CC(B)} = 1.2$ V | <u>[3]</u> _ | 26 | - | μΑ |
| I _{BHH} | bus hold HIGH current | A or B port; $V_I = 0.78$ V; $V_{CC(A)} = V_{CC(B)} = 1.2$ V | <u>[4]</u> _ | -24 | - | μΑ |
| I _{BHLO} | bus hold LOW overdrive current | A or B port; $V_{CC(A)} = V_{CC(B)} = 1.2 V$ | [5] _ | 27 | - | μA |
| I _{BHHO} | bus hold HIGH overdrive current | A or B port; $V_{CC(A)} = V_{CC(B)} = 1.2 \text{ V}$ | <u>[6]</u> _ | -26 | - | μA |

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| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|------------------|---------------------------|---|-----|-----|------|------|------|
| I _{OZ} | OFF-state output current | A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V | [7] | - | ±0.5 | ±2.5 | μA |
| | | suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}$; $V_{CC(A)} = 3.6 V$; $V_{CC(B)} = 0 V$ | [7] | - | ±0.5 | ±2.5 | μA |
| | | suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}$; $V_{CC(A)} = 0 V$; $V_{CC(B)} = 3.6 V$ | [7] | - | ±0.5 | ±2.5 | μA |
| I _{OFF} | power-off leakage current | A port; V _I or V _O = 0 V to 3.6 V; V _{CC(A)} = 0 V; V _{CC(B)} = 0.8 V to 3.6 V | | - | ±0.1 | ±1 | μA |
| | | B port; V _I or V _O = 0 V to 3.6 V; V _{CC(B)} = 0 V; V _{CC(A)} = 0.8 V to 3.6 V | | - | ±0.1 | ±1 | μA |
| CI | input capacitance | DIR, \overline{OE} input; V _I = 0 V or 3.3 V; V _{CC(A)} = V _{CC(B)} = 3.3 V | | - | 1.5 | - | pF |
| C _{I/O} | input/output capacitance | A and B port; $V_O = 3.3$ V or 0 V; $V_{CC(A)} = V_{CC(B)} = 3.3$ V | | - | 4.3 | - | pF |

Table 6. Typical static characteristics at $T_{amb} = 25 \circ C_{11[2]}$... continued At recommended operating conditions: voltages are referenced to GND (around = 0.V).

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

- [3] The bus hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_I to GND and then raising it to V_{IL} max.
- [4] The bus hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_I to V_{CC} and then lowering it to V_{IH} min.

[5] An external driver must source at least I_{BHLO} to switch this node from LOW to HIGH.

- [6] An external driver must sink at least I_{BHHO} to switch this node from HIGH to LOW.
- [7] For I/O ports, the parameter I_{OZ} includes the input leakage current.

Table 7. Static characteristics [1][2]

| Symbol | Parameter | Conditions | _40 °C to | • +85 °C | –40 °C to | +125 °C | Unit |
|--------|---------------|---|-----------------|----------|------------------------|---------|------|
| | | | Min | Max | Min | Max | |
| 11.1 | HIGH-level | data input | | | | | |
| | input voltage | V _{CCI} = 0.8 V | $0.70V_{CCI}$ | - | $0.70V_{CCI}$ | - | V |
| | | $V_{CCI} = 1.1 V \text{ to } 1.95 V$ | $0.65V_{CCI}$ | - | $0.65V_{CCI}$ | - | V |
| | | V_{CCI} = 2.3 V to 2.7 V | 1.6 | - | 1.6 | - | V |
| | | $V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 2 | - | 2 | - | V |
| | | DIR, OE input | | | | | |
| | | $V_{CC(A)} = 0.8 V$ | $0.70V_{CC(A)}$ | - | 0.70V _{CC(A)} | - | V |
| | | $V_{CC(A)} = 1.1 \text{ V to } 1.95 \text{ V}$ | $0.65V_{CC(A)}$ | - | 0.65V _{CC(A)} | - | V |
| | | $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.6 | - | 1.6 | - | V |
| | | $V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2 | - | 2 | - | V |

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| Symbol | Parameter | Conditions | −40 °C t | o +85 °C | –40 °C to | o +125 °C | Uni |
|-----------------|--------------------------|--|-----------------|------------------------|-----------------|------------------------|-----|
| | | | Min | Max | Min | Max | |
| / _{IL} | LOW-level | data input | | | | | |
| | input voltage | $V_{CCI} = 0.8 V$ | - | 0.30V _{CCI} | - | 0.30V _{CCI} | V |
| | | V _{CCI} = 1.1 V to 1.95 V | - | $0.35V_{CCI}$ | - | $0.35V_{CCI}$ | V |
| | | $V_{CCI} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ | - | 0.7 | - | 0.7 | V |
| | | $V_{CCI} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | - | 0.8 | - | 0.8 | V |
| | | DIR, OE input | | | | | |
| | | $V_{CC(A)} = 0.8 V$ | - | 0.30V _{CC(A)} | - | 0.30V _{CC(A)} | V |
| | | V _{CC(A)} = 1.1 V to 1.95 V | - | 0.35V _{CC(A)} | - | 0.35V _{CC(A)} | V |
| | | $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | 0.7 | - | 0.7 | V |
| | | $V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$ | - | 0.8 | - | 0.8 | V |
| он | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | |
| | output voltage | $I_{O} = -100 \ \mu\text{A};$ $V_{CC(A)} = V_{CC(B)} = 0.8 \ \text{V to } 3.6 \ \text{V}$ | $V_{CCO} - 0.1$ | - | $V_{CCO} - 0.1$ | - | V |
| | | $I_{O} = -3 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$ | 0.85 | - | 0.85 | - | V |
| | | $I_{O} = -6 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$ | 1.05 | - | 1.05 | - | V |
| | | $I_{O} = -8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$ | 1.2 | - | 1.2 | - | V |
| | | $I_{O} = -9 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$ | 1.75 | - | 1.75 | - | V |
| | | $I_{O} = -12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$ | 2.3 | - | 2.3 | - | V |
| OL | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | |
| | output voltage | $ I_{O} = 100 \ \mu \text{A}; \\ V_{CC(A)} = V_{CC(B)} = 0.8 \ \text{V to } 3.6 \ \text{V} $ | - | 0.1 | - | 0.1 | V |
| | | $I_{O} = 3 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$ | - | 0.25 | - | 0.25 | V |
| | | $I_{O} = 6 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$ | - | 0.35 | - | 0.35 | V |
| | | I _O = 8 mA; V _{CC(A)} = V _{CC(B)} = 1.65 V | - | 0.45 | - | 0.45 | V |
| | | $I_{O} = 9 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$ | - | 0.55 | - | 0.55 | V |
| | | $I_{O} = 12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$ | - | 0.7 | - | 0.7 | V |
| | input leakage current | DIR, \overline{OE} input; V _I = 0 V or 3.6 V; V _{CC(A)} = V _{CC(B)} = 0.8 V to 3.6 V | - | ±1 | - | ±5 | μA |
| HL | bus hold | A or B port | [3] | | | | |
| | LOW current | $V_{I} = 0.49 \text{ V}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$ | 15 | - | 15 | - | μA |
| | | $V_{I} = 0.58 V;$ $V_{CC(A)} = V_{CC(B)} = 1.65 V$ | 25 | - | 25 | - | μΑ |
| | | $V_{I} = 0.70 \text{ V}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$ | 45 | - | 45 | - | μA |
| | | $V_{I} = 0.80 \text{ V}; V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$ | 100 | - | 90 | - | μA |
| | | | | | | | |

Table 7. Static characteristics ...continued

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| Symbol | Parameter | Conditions | | –40 °C t | o +85 °C | –40 °C to | • +125 °C | Uni |
|-------------------|----------------------|---|------------|----------|----------|-----------|-----------|----------------------|
| | | | | Min | Max | Min | Max | |
| внн | bus hold | A or B port | <u>[4]</u> | | | | | |
| | HIGH current | $V_{I} = 0.91 \text{ V}; V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$ | | -15 | - | -15 | - | μΑ |
| | | $V_{I} = 1.07 \text{ V};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$ | | -25 | - | -25 | - | μA |
| | | $V_{I} = 1.60 \text{ V}; V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$ | | -45 | - | -45 | - | μΑ |
| | | $V_{I} = 2.00 \text{ V}; V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$ | | -100 | - | -100 | - | μΑ |
| BHLO | bus hold | A or B port | [5] | | | | | |
| | LOW overdrive | $V_{CC(A)} = V_{CC(B)} = 1.6 \text{ V}$ | | 125 | - | 125 | - | μA |
| | current | $V_{CC(A)} = V_{CC(B)} = 1.95 V$ | | 200 | - | 200 | - | μA |
| | | $V_{CC(A)} = V_{CC(B)} = 2.7 \text{ V}$ | | 300 | - | 300 | - | μA |
| | | $V_{CC(A)} = V_{CC(B)} = 3.6 \text{ V}$ | | 500 | - | 500 | - | μA |
| I _{BHHO} | bus hold | A or B port | [6] | | | | | - μΑ - μΑ - μΑ |
| | HIGH overdrive | $V_{CC(A)} = V_{CC(B)} = 1.6 V$ | | -125 | - | -125 | - | |
| | current | $V_{CC(A)} = V_{CC(B)} = 1.95 \text{ V}$ | | -200 | - | -200 | - | μA |
| | | $V_{CC(A)} = V_{CC(B)} = 2.7 \text{ V}$ | | -300 | - | -300 | - | μA |
| | | $V_{CC(A)} = V_{CC(B)} = 3.6 \text{ V}$ | | -500 | - | -500 | - | μA |
| OZ | OFF-state output | A or B port; $V_O = 0$ V or V_{CCO} ; $V_{CC(A)} = V_{CC(B)} = 3.6$ V | [7] | - | ±5 | - | ±30 | μΑ |
| | current | suspend mode A port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 3.6 V;$ $V_{CC(B)} = 0 V$ | [7] | - | ±5 | - | ±30 | μA |
| | | suspend mode B port; $V_O = 0 V \text{ or } V_{CCO}; V_{CC(A)} = 0 V;$ $V_{CC(B)} = 3.6 V$ | [7] | - | ±5 | - | ±30 | μA |
| OFF | power-off leakage | A port; V ₁ or V ₀ = 0 V to 3.6 V; V _{CC(A)} = 0 V; V _{CC(B)} = 0.8 V to 3.6 V | | - | ±5 | - | ±30 | μA |
| 0 | current | B port; V _I or V _O = 0 V to 3.6 V; V _{CC(B)} = 0 V; V _{CC(A)} = 0.8 V to 3.6 V | | - | ±5 | - | ±30 | μA |

Table 7. Static characteristics ...continued

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| Symbol | Parameter | Conditions | _40 °C t | o +85 °C | –40 °C to | o +125 °C | Unit |
|--------|-----------|---|----------|----------|-----------|-----------|------|
| | | | Min | Max | Min | Max | |
| сс | supply | A port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A | | | | | |
| | current | $V_{CC(A)} = 0.8 V$ to 3.6 V; $V_{CC(B)} = 0.8 V$ to 3.6 V | - | 10 | - | 55 | μA |
| | | $V_{CC(A)} = 1.1 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.1 \text{ V to } 3.6 \text{ V}$ | - | 8 | - | 50 | μA |
| | | $V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$ | - | 8 | - | 50 | μΑ |
| | | $V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$ | -2 | - | -12 | - | μΑ |
| | | B port; $V_I = 0$ V or V_{CCI} ; $I_O = 0$ A | | | | | |
| | | $V_{CC(A)} = 0.8 V$ to 3.6 V; $V_{CC(B)} = 0.8 V$ to 3.6 V | - | 10 | - | 55 | μA |
| | | $V_{CC(A)} = 1.1 \text{ V to } 3.6 \text{ V};$ $V_{CC(B)} = 1.1 \text{ V to } 3.6 \text{ V}$ | - | 8 | - | 50 | μA |
| | | $V_{CC(A)} = 3.6 \text{ V}; V_{CC(B)} = 0 \text{ V}$ | -2 | - | -12 | - | μΑ |
| | | $V_{CC(A)} = 0 V; V_{CC(B)} = 3.6 V$ | - | 8 | - | 50 | μΑ |
| | | A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0 A$; $V_I = 0 V \text{ or } V_{CCI}$; $V_{CC(A)} = 0.8 V \text{ to } 3.6 V$; $V_{CC(B)} = 0.8 V \text{ to } 3.6 V$ | - | 20 | - | 70 | μA |
| | | A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI} ; $V_{CC(A)} = 1.1$ V to 3.6 V; $V_{CC(B)} = 1.1$ V to 3.6 V | - | 16 | - | 65 | μA |

Table 7. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the data input port.

[3] The bus hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_I to GND and then raising it to V_{IL} max.

- [4] The bus hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_I to V_{CC} and then lowering it to V_{IH} min.
- [5] An external driver must source at least I_{BHLO} to switch this node from LOW to HIGH.
- [6] An external driver must sink at least I_{BHHO} to switch this node from HIGH to LOW.

[7] For I/O ports, the parameter I_{OZ} includes the input leakage current.

Table 8. Typical total supply current (I_{CC(A)} + I_{CC(B)})

| V _{CC(A)} | V _{CC(B)} | V _{CC(B)} | | | | | | | | | |
|--------------------|--------------------|--------------------|-------|-------|-------|-------|-------|----|--|--|--|
| | 0 V | 0.8 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | | | | |
| 0 V | 0 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | μA | | | |
| 0.8 V | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.3 | 1.6 | μA | | | |
| 1.2 V | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.8 | μA | | | |
| 1.5 V | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.4 | μA | | | |
| 1.8 V | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | 0.2 | μA | | | |
| 2.5 V | 0.1 | 0.3 | 0.1 | 0.1 | 0.1 | 0.1 | 0.1 | μΑ | | | |
| 3.3 V | 0.1 | 1.6 | 0.8 | 0.4 | 0.2 | 0.1 | 0.1 | μA | | | |

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10. Dynamic characteristics

Table 9.

Table 9.Typical dynamic characteristics at $V_{CC(A)} = 0.8 V$ and $T_{amb} = 25 \ ^{\circ}C \ ^{(1)}$ Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for wave forms see Figure 5 and Figure 6

| Symbol | Parameter | Conditions | V _{CC(B)} | | | | | | |
|------------------|-------------------------------|------------|--------------------|-------|-------|-------|-------|------|----|
| | | 0.8 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | | |
| t _{pd} | propagation delay | An to Bn | 14.4 | 7.0 | 6.2 | 6.0 | 5.9 | 6.0 | ns |
| | Bn to An | 14.4 | 12.4 | 12.1 | 11.9 | 11.8 | 11.8 | ns | |
| t _{dis} | t _{dis} disable time | OE to An | 16.2 | 16.2 | 16.2 | 16.2 | 16.2 | 16.2 | ns |
| | | OE to Bn | 17.6 | 10.0 | 9.0 | 9.1 | 8.7 | 9.3 | ns |
| t _{en} | enable time | OE to An | 21.9 | 21.9 | 21.9 | 21.9 | 21.9 | 21.9 | ns |
| | | OE to Bn | 22.2 | 11.1 | 9.8 | 9.4 | 9.4 | 9.6 | ns |

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

Table 10. Typical dynamic characteristics at $V_{CC(B)} = 0.8$ V and $T_{amb} = 25 \circ C$ [1]

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7; for wave forms see Figure 5 and Figure 6

| Symbol | Parameter | Conditions | V _{CC(A)} | | | | | | |
|------------------|-------------------------------|------------|--------------------|-------|-------|-------|-------|------|----|
| | | 0.8 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | | |
| t _{pd} | propagation delay | An to Bn | 14.4 | 12.4 | 12.1 | 11.9 | 11.8 | 11.8 | ns |
| | Bn to An | 14.4 | 7.0 | 6.2 | 6.0 | 5.9 | 6.0 | ns | |
| t _{dis} | t _{dis} disable time | OE to An | 16.2 | 5.9 | 4.4 | 4.2 | 3.1 | 3.5 | ns |
| | | OE to Bn | 17.6 | 14.2 | 13.7 | 13.6 | 13.3 | 13.1 | ns |
| t _{en} | t _{en} enable time | OE to An | 21.9 | 6.4 | 4.4 | 3.5 | 2.6 | 2.3 | ns |
| | | OE to Bn | 22.2 | 17.7 | 17.2 | 17.0 | 16.8 | 16.7 | ns |

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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| Symbol | Parameter | Conditions | | | V _{CC(A)} = | = V _{CC(B)} | | | Unit |
|----------|--|--|-------|-------|----------------------|----------------------|-------|-------|------|
| | | | 0.8 V | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | |
| C_{PD} | power dissipation capacitance | A port: (direction A to B); output enabled | 0.2 | 0.2 | 0.2 | 0.3 | 0.4 | 0.5 | pF |
| | | A port: (direction A to B); output disabled | 0.2 | 0.2 | 0.2 | 0.3 | 0.4 | 0.5 | pF |
| | A port: (direction B to A); output enabled | 9 | 9 | 10 | 10 | 11 | 13 | pF | |
| | A port: (direction B to A); output disabled | 0.6 | 0.6 | 0.6 | 0.7 | 0.7 | 0.8 | pF | |
| | B port: (direction A to B); output enabled | 9 | 9 | 10 | 10 | 11 | 13 | pF | |
| | | B port: (direction A to B); output disabled | 0.6 | 0.6 | 0.6 | 0.7 | 0.7 | 0.8 | pF |
| | | B port: (direction B to A); output enabled | 0.2 | 0.2 | 0.2 | 0.3 | 0.4 | 0.5 | pF |
| | | B port: (direction B to A); output disabled | 0.2 | 0.2 | 0.2 | 0.3 | 0.4 | 0.5 | pF |

Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \ ^{\circ}C \ \underline{[1][2]}$ Voltages are referenced to GND (ground = 0 V).

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

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| Symbol | Parameter | Conditions | V _{CC(B)} | | | | | | | | | Unit | |
|----------------------|----------------|------------------------------|--------------------|---------|---------|---------|-----|--------|---------|---------|-------|---------|----|
| | | | 1.2 V : | ± 0.1 V | 1.5 V : | ± 0.1 V | | 0.15 V | 2.5 V : | ± 0.2 V | 3.3 V | ± 0.3 V | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | |
| $V_{CC(A)} =$ | 1.1 V to 1.3 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 9.0 | 0.5 | 6.7 | 0.5 | 5.8 | 0.5 | 4.9 | 0.5 | 4.8 | ns |
| | delay | Bn to An | 0.5 | 9.0 | 0.5 | 8.5 | 0.5 | 8.3 | 0.5 | 8.0 | 0.5 | 7.8 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 11.8 | 0.5 | 11.8 | 0.5 | 11.8 | 0.5 | 11.8 | 0.5 | 11.8 | ns |
| | | OE to Bn | 0.5 | 12.3 | 0.5 | 9.5 | 0.5 | 9.4 | 0.5 | 8.0 | 0.5 | 8.9 | ns |
| t _{en} | enable time | OE to An | 1.1 | 14.4 | 1.1 | 14.4 | 1.1 | 14.4 | 1.1 | 14.4 | 1.1 | 14.4 | ns |
| | | OE to Bn | 1.1 | 14.2 | 1.1 | 10.4 | 1.1 | 9.0 | 1.0 | 7.7 | 1.0 | 7.3 | ns |
| V _{CC(A)} = | 1.4 V to 1.6 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 8.5 | 0.5 | 5.6 | 0.5 | 4.7 | 0.5 | 4.4 | 0.5 | 4.1 | ns |
| | delay | Bn to An | 0.5 | 6.7 | 0.5 | 5.6 | 0.5 | 5.3 | 0.5 | 5.2 | 0.5 | 5.0 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | 0.5 | 8.6 | ns |
| | | OE to Bn | 0.5 | 11.2 | 0.5 | 8.4 | 0.5 | 7.6 | 0.5 | 7.2 | 0.5 | 7.8 | ns |
| t _{en} | enable time | OE to An | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | 1.1 | 8.7 | ns |
| | | OE to Bn | 1.1 | 12.8 | 1.1 | 8.1 | 1.1 | 7.1 | 1.0 | 5.6 | 1.0 | 5.2 | ns |
| V _{CC(A)} = | 1.65 V to 1.95 | V | | | | | | | | | | | |
| t _{pd} | | An to Bn | 0.5 | 8.3 | 0.5 | 5.3 | 0.5 | 4.5 | 0.5 | 3.8 | 0.5 | 3.5 | ns |
| | delay | Bn to An | 0.5 | 5.8 | 0.5 | 4.7 | 0.5 | 4.5 | 0.5 | 4.3 | 0.5 | 4.1 | ns |
| t _{dis} | disable time | \overline{OE} to An | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | 0.5 | 7.1 | ns |
| | | \overline{OE} to Bn | 0.5 | 10.9 | 0.5 | 7.8 | 0.5 | 6.9 | 0.5 | 6.0 | 0.5 | 5.8 | ns |
| t _{en} | enable time | \overline{OE} to An | 1.0 | 6.8 | 1.0 | 6.8 | 1.0 | 6.8 | 1.0 | 6.8 | 1.0 | 6.8 | ns |
| | | $\overline{\text{OE}}$ to Bn | 1.1 | 12.4 | 1.1 | 8.2 | 1.0 | 6.7 | 0.5 | 5.1 | 0.5 | 4.5 | ns |
| $V_{CC(A)} =$ | 2.3 V to 2.7 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 8.0 | 0.5 | 5.2 | 0.5 | 4.3 | 0.5 | 3.3 | 0.5 | 2.9 | ns |
| | delay | Bn to An | 0.5 | 4.9 | 0.5 | 4.4 | 0.5 | 3.8 | 0.5 | 3.3 | 0.5 | 3.1 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | 0.5 | 5.1 | ns |
| | | OE to Bn | 0.5 | 10.4 | 0.5 | 7.1 | 0.5 | 6.3 | 0.5 | 5.1 | 0.5 | 5.2 | ns |
| t _{en} | enable time | OE to An | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | 0.5 | 4.8 | ns |
| | | OE to Bn | 1.1 | 11.9 | 1.1 | 7.9 | 0.5 | 6.4 | 0.5 | 4.6 | 0.5 | 4.0 | ns |
| V _{CC(A)} = | 3.0 V to 3.6 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 7.8 | 0.5 | 5.0 | 0.5 | 4.1 | 0.5 | 3.1 | 0.5 | 2.7 | ns |
| | delay | Bn to An | 0.5 | 4.8 | 0.5 | 4.1 | 0.5 | 3.5 | 0.5 | 2.9 | 0.5 | 2.7 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 4.9 | 0.5 | 4.9 | 0.5 | 4.9 | 0.5 | 4.9 | 0.5 | 4.9 | ns |
| | | OE to Bn | 0.5 | 10.1 | 0.5 | 6.9 | 0.5 | 6.0 | 0.5 | 4.8 | 0.5 | 5.0 | ns |
| t _{en} | enable time | OE to An | 0.5 | 4.0 | 0.5 | 4.0 | 0.5 | 4.0 | 0.5 | 4.0 | 0.5 | 4.0 | ns |
| | | OE to Bn | 1.1 | 11.7 | 1.1 | 7.8 | 0.5 | 6.2 | 0.5 | 4.5 | 0.5 | 3.9 | ns |

Table 12. Dynamic characteristics for temperature range $-40 \degree$ C to $+85 \degree$ C [1] Voltages are referenced to GND (ground = 0.V): for test circuit see Figure 7: for wave forms see Figure 5 and Figure 6.

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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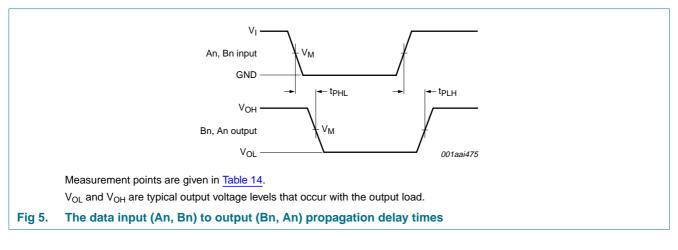
| Symbol | Parameter | Conditions | V _{CC(B)} | | | | | | | | | Unit | |
|----------------------|----------------|------------------------------|--------------------|------|-------------------|------|--------------------|------|-------|---------|-------|---------|----|
| - | | | $1.2~V\pm0.1~V$ | | 1.5 V \pm 0.1 V | | 1.8 V \pm 0.15 V | | 2.5 V | ± 0.2 V | 3.3 V | ± 0.3 V | - |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max | |
| $V_{CC(A)} =$ | 1.1 V to 1.3 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 9.9 | 0.5 | 7.4 | 0.5 | 6.4 | 0.5 | 5.4 | 0.5 | 5.3 | ns |
| | delay | Bn to An | 0.5 | 9.9 | 0.5 | 9.4 | 0.5 | 9.2 | 0.5 | 8.8 | 0.5 | 8.6 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 13.0 | 0.5 | 13.0 | 0.5 | 13.0 | 0.5 | 13.0 | 0.5 | 13.0 | ns |
| | | OE to Bn | 0.5 | 13.6 | 0.5 | 10.5 | 0.5 | 10.4 | 0.5 | 8.8 | 0.5 | 9.8 | ns |
| t _{en} | enable time | $\overline{\text{OE}}$ to An | 1.1 | 15.9 | 1.1 | 15.9 | 1.1 | 15.9 | 1.1 | 15.9 | 1.1 | 15.9 | ns |
| | | OE to Bn | 1.1 | 15.7 | 1.1 | 11.5 | 1.1 | 9.9 | 1.0 | 8.5 | 1.0 | 8.1 | ns |
| V _{CC(A)} = | 1.4 V to 1.6 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 9.4 | 0.5 | 6.2 | 0.5 | 5.2 | 0.5 | 4.9 | 0.5 | 4.6 | ns |
| | delay | Bn to An | 0.5 | 7.4 | 0.5 | 6.2 | 0.5 | 5.9 | 0.5 | 5.8 | 0.5 | 5.5 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 9.5 | 0.5 | 9.5 | 0.5 | 9.5 | 0.5 | 9.5 | 0.5 | 9.5 | ns |
| | | OE to Bn | 0.5 | 12.4 | 0.5 | 9.3 | 0.5 | 8.4 | 0.5 | 8.0 | 0.5 | 8.6 | ns |
| t _{en} | enable time | OE to An | 1.1 | 9.6 | 1.1 | 9.6 | 1.1 | 9.6 | 1.1 | 9.6 | 1.1 | 9.6 | ns |
| | | OE to Bn | 1.1 | 14.1 | 1.1 | 9.0 | 1.1 | 7.9 | 1.0 | 6.2 | 1.0 | 5.8 | ns |
| V _{CC(A)} = | 1.65 V to 1.95 | V | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 9.2 | 0.5 | 5.9 | 0.5 | 5.0 | 0.5 | 4.2 | 0.5 | 3.9 | ns |
| | delay | Bn to An | 0.5 | 6.4 | 0.5 | 5.2 | 0.5 | 5.0 | 0.5 | 4.8 | 0.5 | 4.6 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 7.9 | 0.5 | 7.9 | 0.5 | 7.9 | 0.5 | 7.9 | 0.5 | 7.9 | ns |
| | | OE to Bn | 0.5 | 12.0 | 0.5 | 8.6 | 0.5 | 7.6 | 0.5 | 6.6 | 0.5 | 6.4 | ns |
| t _{en} | enable time | OE to An | 1.0 | 7.5 | 1.0 | 7.5 | 1.0 | 7.5 | 1.0 | 7.5 | 1.0 | 7.5 | ns |
| | | OE to Bn | 1.1 | 13.7 | 1.1 | 9.1 | 1.0 | 7.4 | 0.5 | 5.7 | 0.5 | 5.0 | ns |
| V _{CC(A)} = | 2.3 V to 2.7 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 8.8 | 0.5 | 5.8 | 0.5 | 4.8 | 0.5 | 3.7 | 0.5 | 3.2 | ns |
| | delay | Bn to An | 0.5 | 5.4 | 0.5 | 4.9 | 0.5 | 4.2 | 0.5 | 3.7 | 0.5 | 3.5 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 5.7 | 0.5 | 5.7 | 0.5 | 5.7 | 0.5 | 5.7 | 0.5 | 5.7 | ns |
| | | OE to Bn | 0.5 | 11.5 | 0.5 | 7.9 | 0.5 | 7.0 | 0.5 | 5.7 | 0.5 | 5.8 | ns |
| t _{en} | enable time | OE to An | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | 0.5 | 5.3 | ns |
| | | OE to Bn | 1.1 | 13.1 | 1.1 | 8.7 | 0.5 | 7.1 | 0.5 | 5.1 | 0.5 | 4.4 | ns |
| V _{CC(A)} = | 3.0 V to 3.6 V | | | | | | | | | | | | |
| t _{pd} | propagation | An to Bn | 0.5 | 8.6 | 0.5 | 5.5 | 0.5 | 4.6 | 0.5 | 3.5 | 0.5 | 3.0 | ns |
| | delay | Bn to An | 0.5 | 5.3 | 0.5 | 4.6 | 0.5 | 3.9 | 0.5 | 3.2 | 0.5 | 3.0 | ns |
| t _{dis} | disable time | OE to An | 0.5 | 5.4 | 0.5 | 5.4 | 0.5 | 5.4 | 0.5 | 5.4 | 0.5 | 5.4 | ns |
| | | OE to Bn | 0.5 | 11.2 | 0.5 | 7.6 | 0.5 | 6.6 | 0.5 | 5.3 | 0.5 | 5.5 | ns |
| t _{en} | enable time | OE to An | 0.5 | 4.4 | 0.5 | 4.4 | 0.5 | 4.4 | 0.5 | 4.4 | 0.5 | 4.4 | ns |
| 511 | | OE to Bn | 1.1 | 12.9 | 1.1 | 8.6 | 0.5 | 6.9 | 0.5 | 5.0 | 0.5 | 4.3 | ns |

Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C [1]

[1] t_{pd} is the same as t_{PLH} and t_{PHL} ; t_{dis} is the same as t_{PLZ} and t_{PHZ} ; t_{en} is the same as t_{PZL} and t_{PZH} .

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11. Waveforms



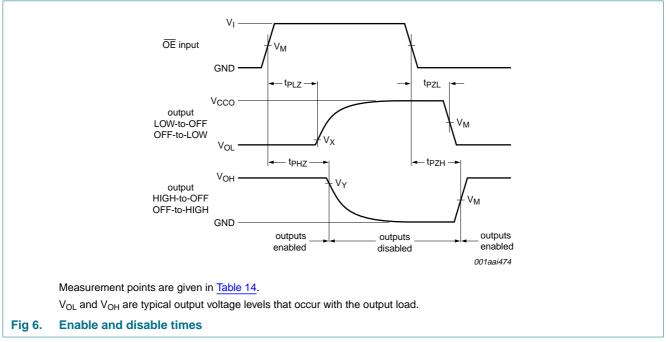


Table 14.Measurement points

| Supply voltage | Input ^[1] | Output ^[2] | | |
|---|----------------------|-----------------------|--------------------------|--------------------------|
| V _{CC(A)} , V _{CC(B)} | V _M | V _M | V _X | V _Y |
| 0.8 V to 1.6 V | 0.5V _{CCI} | 0.5V _{CCO} | V _{OL} + 0.1 V | V _{OH} – 0.1 V |
| 1.65 V to 2.7 V | 0.5V _{CCI} | $0.5V_{CCO}$ | V _{OL} + 0.15 V | V _{OH} – 0.15 V |
| 3.0 V to 3.6 V | 0.5V _{CCI} | $0.5V_{CCO}$ | V _{OL} + 0.3 V | V _{OH} – 0.3 V |

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

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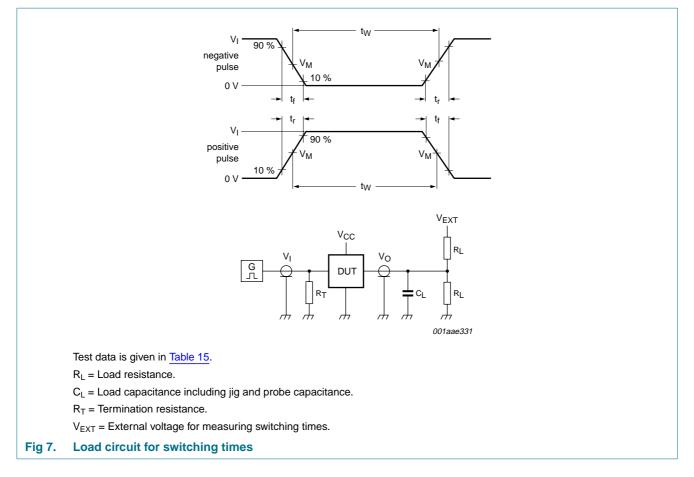


Table 15. Test data

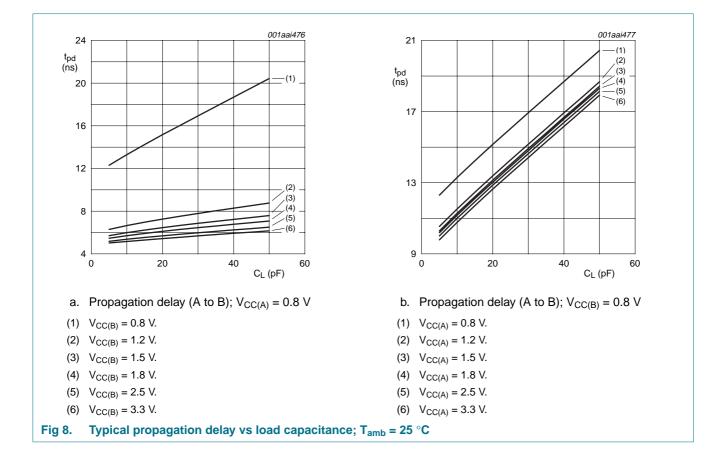
| Supply voltage | Input | | Load | Load | | V _{EXT} | | | |
|---|--------------------|-----------------|-------|------|-------------------------------------|-------------------------------------|---|--|--|
| V _{CC(A)} , V _{CC(B)} | V _I [1] | ∆t/∆V[2] | CL | RL | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} [3] | | |
| 0.8 V to 1.6 V | V _{CCI} | \leq 1.0 ns/V | 15 pF | 2 kΩ | open | GND | 2V _{CCO} | | |
| 1.65 V to 2.7 V | V _{CCI} | \leq 1.0 ns/V | 15 pF | 2 kΩ | open | GND | 2V _{CCO} | | |
| 3.0 V to 3.6 V | V _{CCI} | \leq 1.0 ns/V | 15 pF | 2 kΩ | open | GND | 2V _{CCO} | | |

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] $dV/dt \ge 1.0 V/ns$

[3] V_{CCO} is the supply voltage associated with the output port.

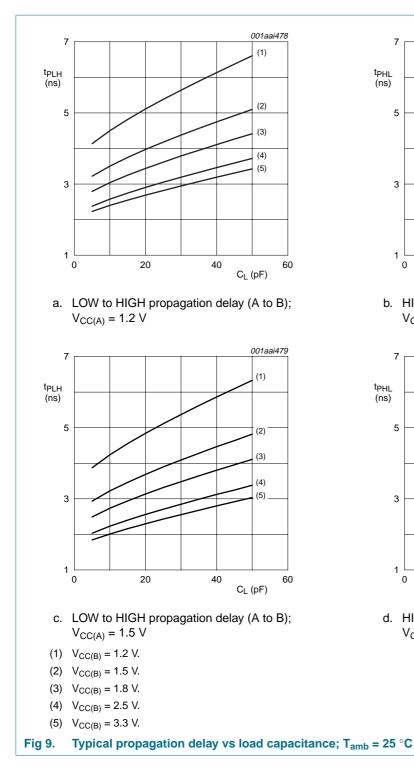
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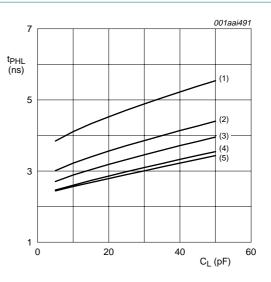


12. Typical propagation delay characteristics

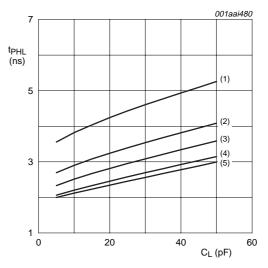
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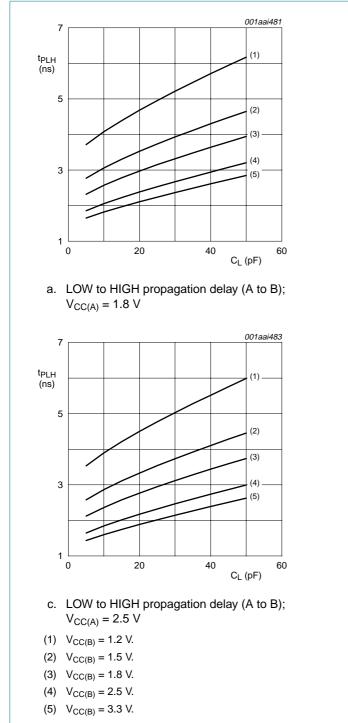
b. HIGH to LOW propagation delay (A to B); $V_{CC(A)} = 1.2 \text{ V}$

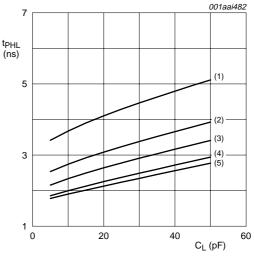


d. HIGH to LOW propagation delay (A to B); $V_{CC(A)} = 1.5 \text{ V}$

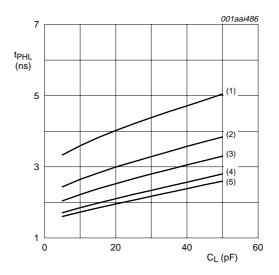
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b. HIGH to LOW propagation delay (A to B); $V_{CC(A)} = 1.8 \text{ V}$

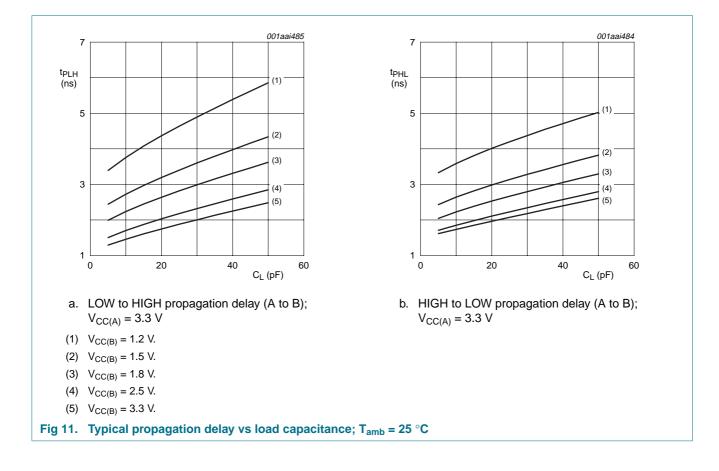


d. HIGH to LOW propagation delay (A to B); $V_{CC(A)} = 2.5 \text{ V}$

Fig 10. Typical propagation delay vs load capacitance; T_{amb} = 25 $^\circ\text{C}$

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13. Package outline

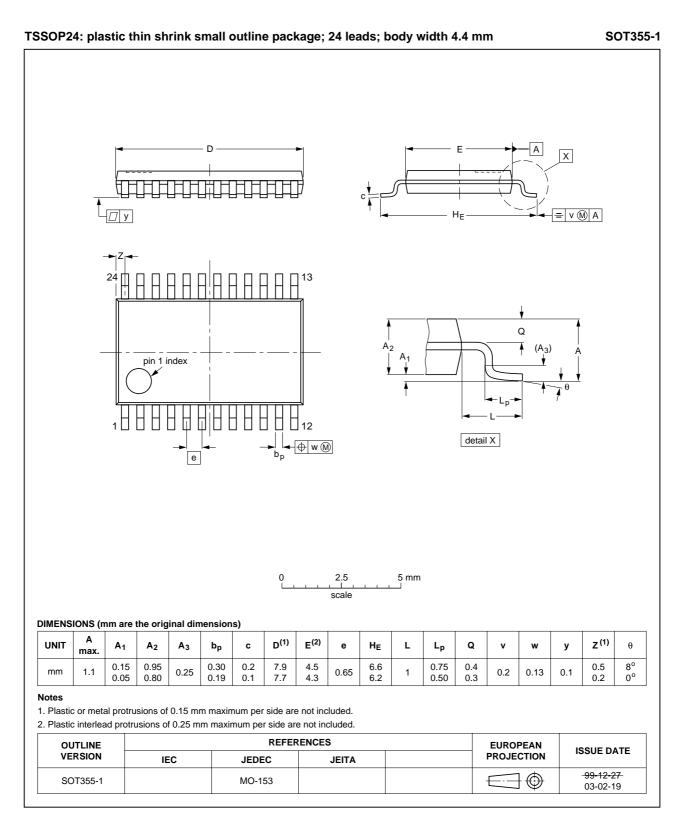
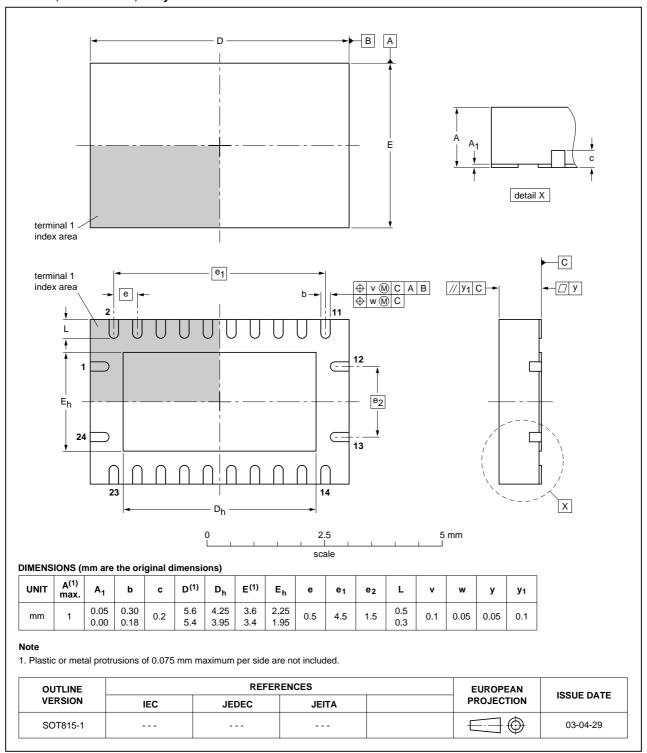


Fig 12. Package outline SOT355-1 (TSSOP24)

SOT815-1

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 13. Package outline SOT815-1 (DHVQFN24)

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14. Abbreviations

| AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal Oxide SemiconductorDUTDevice Under TestESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model | Table 16. | Abbreviations |
|--|-----------|---|
| CMOSComplementary Metal Oxide SemiconductorDUTDevice Under TestESDElectroStatic DischargeHBMHuman Body Model | Acronym | Description |
| DUTDevice Under TestESDElectroStatic DischargeHBMHuman Body Model | CDM | Charged Device Model |
| ESD ElectroStatic Discharge HBM Human Body Model | CMOS | Complementary Metal Oxide Semiconductor |
| HBM Human Body Model | DUT | Device Under Test |
| | ESD | ElectroStatic Discharge |
| MM Machine Model | HBM | Human Body Model |
| | MM | Machine Model |

15. Revision history

| Table 17. Revision his | tory | | | |
|------------------------|--------------|--|------------------|---------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74AVCH8T245_2 | 20090428 | Product data sheet | - | 74AVCH8T245_1 |
| Modifications: | | nning information": names changed in pin de | scription table. | |
| 74AVCH8T245_1 | 20080709 | Product data sheet | - | - |

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16.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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